- Power-On Reset Generator
- Automatic Reset Generation After Voltage Drop
- RESET Output Defined From V<sub>CC</sub> ≥ 1 V
- Precision Voltage Sensor
- Temperature-Compensated Voltage Reference
- True and Complement Reset Outputs
- Externally Adjustable Pulse Duration

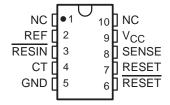
### description

The TL7702B and TL7705B are integrated-circuit supply-voltage supervisors designed for use as reset controllers in microcomputer microprocessor systems. The supply-voltage supervisor monitors the supply for undervoltage conditions at the SENSE input. During power up, the RESET output becomes active (low) when V<sub>CC</sub> attains a value approaching 1 V. As V<sub>CC</sub> approaches 3 V (assuming that SENSE is above V<sub>T+</sub>), the delay timer function activates a time delay, after which outputs RESET and RESET go inactive (high and low, respectively). When an undervoltage condition occurs during normal operation, outputs RESET and RESET go active. To ensure that a complete reset occurs, the reset outputs remain active for a time delay after the voltage at the SENSE input exceeds the positive-going threshold value. The time delay is determined by the value of the external capacitor  $C_T$ :  $t_d \approx 2.6 \times 10^4 \times C_T$ , where  $C_T$  is in farads (F) and t<sub>d</sub> is in seconds (s).

An external capacitor (typically 0.1  $\mu$ F) must be connected to REF to reduce the influence of fast transients in the supply voltage.

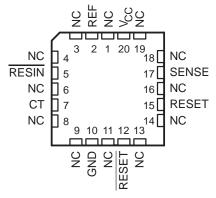
TL77xxBC...D OR P PACKAGE TL7705BM . . . JG PACKAGE TL7705BQ . . . D PACKAGE (TOP VIEW) D ∨<sub>CC</sub> **REF** 8 RESIN [ SENSE 2 7 СТ 🛮 6 RESET 3 GND [ RESET

TL7705BM . . . U PACKAGE (TOP VIEW)



NC - No internal connection

# TL7705BM . . . FK PACKAGE (TOP VIEW)



NC - No internal connection

The TL7702BC and TL7705BC are characterized for operation from 0°C to 70°C. The TL7702BI and TL7705BI are characterized for operation from -40°C to 85°C. The TL7705BQ is characterized for operation from -40°C to 125°C. The TL7705BM is characterized for operation from -55°C to 125°C.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.



# TL7702B, TL7705B SUPPLY-VOLTAGE SUPERVISORS

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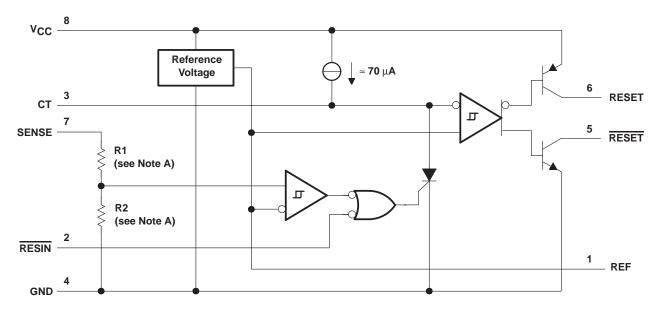
### **AVAILABLE OPTIONS**

		PA	CKAGED DEVIC	ES		
TA	SMALL OUTLINE (D)	CHIP CARRIER (FK)	CERAMIC DIP (JG)	PLASTIC DIP (P)	CERAMIC FLATPACK (U)	CHIP FORM (Y)
0°C to 70°C	TL7702BCD	_	_	TL7702BCP	_	
0 0 10 70 0	TL7705BCD	_	_	TL7705BCP	_	
-40°C to 85°C	TL7702BID	_	_	TL7702BIP	_	TL7702BY,
=40°C to 85°C	TL7705BID	_	_	TL7705BIP	_	TL7705BY
-40°C to 125°C	TL7705BQD	_	_	_	_	
–55°C to 125°C	_	TL7702BMFK	TL7702BMJG	_	TL7702BMU	
-55 C to 125 C	_	TL7705BMFK	TL7705BMJG	_	TL7705BMU	

The D package is available taped and reeled. Add the suffix R to device type (e.g., TL7702BCDR). Chip forms are tested at 25°C.

## functional block diagram

The functional block diagram is shown for illustrative purposes only; the actual circuit includes a trimming network to adjust the reference voltage and sense-comparator trip point.

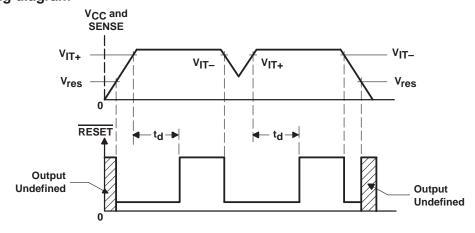


Pin numbers shown are for the D, JG, and P packages.

NOTE A: TL7702B: R1 = 0  $\Omega$ , R2 = open

TL7705B: R1 = 23 k $\Omega$ , R2 = 10 k $\Omega$ , nominal

## typical timing diagram



# TL7702B, TL7705B SUPPLY-VOLTAGE SUPERVISORS

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### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage, V <sub>CC</sub> (see Note 1)	20 V
Input voltage range, V <sub>I</sub> : RESIN	3 V to 20 V
SENSE	3 V to 20 V
High-level output current, I <sub>OH</sub> (RESET)	–30 mA
Low-level output current, I <sub>OL</sub> (RESET)	30 mA
Package thermal impedance, θ <sub>JA</sub> (see Notes 2 and 3): D package	97°C/W
P package	. 127°C/W
Case temperature for 60 seconds, T <sub>C</sub> : FK package	260°C
Lead temperature 1,6 mm (1/16 inch) from case for 60 seconds: JG or U packages	300°C
Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds: D or P packages	260°C
Storage temperature range, T <sub>stg</sub>	C to 150°C

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. All voltage values are with respect to the network ground terminal.

- 2. Maximum power dissipation is a function of  $T_J(max)$ ,  $\theta_{JA}$ , and  $T_A$ . The maximum allowable power dissipation at any allowable ambient temperature is  $P_D = (T_J(max) T_A)/\theta_{JA}$ . Operating at the absolute maximum  $T_J$  of 150°C can impact reliability.
- 3. The package thermal impedance is calculated in accordance with JESD 51, except for through-hole packages, which use a trace length of zero.

### recommended operating conditions

		MIN	MAX	UNIT
Supply voltage, V <sub>CC</sub>		3.6	18	V
High-level input voltage, V <sub>IH</sub>	RESIN	2	18	V
Low-level input voltage, V <sub>IL</sub>	RESIN	0	0.8	V
Input voltage, V <sub>I</sub>	SENSE	0	18	V
High-level output current, IOH	RESET		-16	mA
Low-level output current, IOL	RESET		16	mA
	TL770xBC	0	70	
Operating free air temperature range. To	TL770xBI	-40	85	°C
Operating free-air temperature range, T <sub>A</sub>	TL7705BQ	-40	125	-0
	TL7705BM	-55	2 18 0 0.8 0 18 -16 16 0 70 0 85 0 125	



# electrical characteristics over recommended operating conditions (unless otherwise noted)

PARAMETER			TEST CONDITIONS†		TL77xxBC TL77xxBI TL7705BQ			UNIT	
						MIN	TYP	MAX	
Vон	High-level output vo	oltage, RES	ET	I <sub>OH</sub> = -16 mA		V <sub>CC</sub> -1.5			V
VOL	Low-level output vo	ltage, RES	ET	I <sub>OL</sub> = 16 mA				0.4	V
V <sub>ref</sub>	Reference voltage			$I_{ref} = 500  \mu A$ ,	T <sub>A</sub> = 25°C	2.48	2.53	2.58	V
			TL7702B	T 25°C		2.505	2.53	2.555	
\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \	Negative-going		TL7705B	$T_A = 25^{\circ}C$		4.5	4.55	4.6	V
VIT-	input threshold voltage at SENSE input		TL7702B	- · · · +		2.48	2.53	2.58	V
			TL7705B	T <sub>A</sub> = full range‡		4.45	4.55	4.65	
\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \	Hysteresis, SENSE		TL7702B	Va a 2 6 V to 40 V	T- 050C		10		mV
V <sub>hys</sub>	$(V_{\text{IT+}} - V_{\text{IT-}})$	TL	TL7705B	$V_{CC} = 3.6 \text{ V to } 18 \text{ V},$	$T_A = 25^{\circ}C$		30		IIIV
V <sub>res</sub> §	Power-up reset vol	tage		I <sub>OL</sub> at RESET = 2 mA,	T <sub>A</sub> = 25°C			1	V
Γ.	Innut aurent	RESIN		$V_I = 0.4 \text{ V to V}_{CC}$				-10	^
'1	Input current	SENSE	TL7702B	V <sub>I</sub> = V <sub>ref</sub> to 18 V			-0.1	-2	μΑ
ІОН	High-level output co	urrent, RESET		V <sub>O</sub> = 18 V,	See Figure 1			50	μΑ
lOL	Low-level output cu	Low-level output current, RESET		$V_{O} = 0 V$ ,	See Figure 1			-50	μΑ
	Completerant			V <sub>SENSE</sub> = 15 V,	RESIN ≥ 2 V		1.8	3	mA
Icc	Supply current			V <sub>CC</sub> = 18 V,	T <sub>A</sub> = full range‡			3.5	mA

# switching characteristics, $V_{CC} = 5 \text{ V}$ , CT open, $T_A = 25^{\circ}\text{C}$

PARAMETER		FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	TL77xxBC TL77xxBI TL7705BQ			UNIT	
					MIN	TYP	MAX		
<sup>t</sup> PLH	Propagation delay time from low- to high-level output	RESIN	RESET	See Figures 1, 2, and 3		270	500	ns	
<sup>t</sup> PHL	Propagation delay time from high- to low-level output	RESIN	RESET			270	500	ns	
	Effective pulse duration	RESIN		See Figure 2		150		ns	
t <sub>W</sub>	Effective pulse duration	SENSE	1	See Figure 2		100		115	
t <sub>r</sub>	Rise time		DECET				75	no	
t <sub>f</sub>	Fall time		RESET	Con Figures 4 and 2		150	200	ns	
t <sub>r</sub>	Rise time		RESET	See Figures 1 and 3		75	150	ns	
tf	Fall time		KESET				50	115	

<sup>†</sup> All electrical characteristics are measured with 0.1-μF capacitors connected at REF, CT, and V<sub>CC</sub> to GND. ‡ Full range is 0°C to 70°C for the C-suffix devices, -40°C to 85°C for the I-suffix devices, and -40°C to 125°C for the Q-suffix device. § This is the lowest voltage at which RESET becomes active.

# TL7702B, TL7705B SUPPLY-VOLTAGE SUPERVISORS

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# electrical characteristics over recommended operating conditions (unless otherwise noted)

PARAMETER				TEST CONDITIONS†		705BM		UNIT	
FARAMETER		TEST CONDI	TIONS	MIN	TYP	MAX	UNIT		
Vон	High-level output vo	oltage, RES	ET	I <sub>OH</sub> = -16 mA		V <sub>CC</sub> -1.5			V
VOL	Low-level output vo	ltage, RES	ET	I <sub>OL</sub> = 16 mA				0.4	V
V <sub>ref</sub>	Reference voltage			$I_{ref} = 500  \mu A$ ,	T <sub>A</sub> = 25°C	2.48	2.53	2.58	V
			TL7702B	T. 250C		2.505	2.53	2.555	
,_	Negative-going		TL7705B	T <sub>A</sub> = 25°C		4.5	4.55	4.6	V
	at SENSE input	input threshold voltage at SENSE input				2.48	2.53	2.58	V
	at of the most		TL7705B	$T_A = -55^{\circ}C \text{ to } 125^{\circ}C$		4.45	4.55	4.65	
\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \	Hysteresis, SENSE TL77		TL7702B	V 00V4 40V	T 0500		10		
V <sub>hys</sub>	$(V_{IT+} - V_{IT-})$		TL7705B	$V_{CC} = 3.6 \text{ V to } 18 \text{ V},$	$T_A = 25^{\circ}C$		30		mV
v <sub>res</sub> ‡	Power-up reset volt	tage		I <sub>OL</sub> at RESET = 2 mA,	T <sub>A</sub> = 25°C			1	V
1.	lanut aurrant	RESIN		$V_I = 0.4 \text{ V to } V_{CC}$				-10	^
11	Input current	SENSE	TL7702B	$V_I = V_{ref}$ to $V_{CC} - 1.5 V$			-0.1	-2	μΑ
IOH	High-level output co	output current, RESET		V <sub>O</sub> = 18 V				50	μΑ
lOL	Low-level output cu	v-level output current, RESET		VO = 0				-50	μΑ
	Supply current			V <sub>SENSE</sub> = 15 V,	RESIN ≥ 2 V		1.8	3	
ICC			V <sub>CC</sub> = 18 V,	$T_A = -55^{\circ}C$ to 125°C			4	mA	

<sup>†</sup> All electrical characteristics are measured with 0.1-μF capacitors connected at REF, CT, and V<sub>CC</sub> to GND. ‡ This is the lowest value at which RESET becomes active.

# switching characteristics, $V_{CC}$ = 5 V, CT open, $T_A$ = 25°C

PARAMETER		FROM	то	TO TEST CONDITIONS		TL7705BM				
	PARAMETER	(INPUT) (OUTPUT)		TEST CONDITIONS	MIN	TYP	MAX	UNIT		
tPLH	Propagation delay time from low- to high-level output	RESIN	RESET	See Figures 1, 2, and 3		270	500*	ns		
tPHL	Propagation delay time from high- to low-level output	RESIN	RESET	See Figures 1, 2, and 3		270	500*	ns		
_	Effective pulse duration	Effective pulse duration	RESIN		Coo Figure 2		150			
t <sub>W</sub>		SENSE		See Figure 2		100		ns		
t <sub>r</sub>	Rise time		DECET	Coo Figures 4 and 2			75*	ns		
t <sub>f</sub>	Fall time		RESET			150	200*	115		
t <sub>r</sub>	Rise time		RESET	See Figures 1 and 3		75	150*	ns		
t <sub>f</sub>	Fall time		RESET				50*	115		

<sup>\*</sup> On products compliant to MIL-PRF-38535, these parameters are not production tested.

## electrical characteristics over recommended operating conditions, $T_A$ = 25°C (unless otherwise noted)

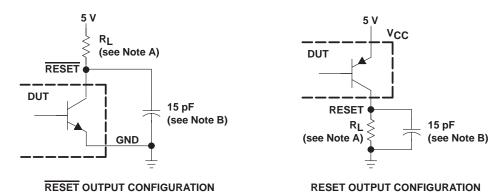
	PARAMETER			TEST CONDITIONS <sup>†</sup>		TL7702BY TL7705BY			UNIT
							TYP	MAX	
Vон	High-level output voltage, RE	SET		I <sub>OH</sub> = -16 mA		V <sub>CC</sub> -1.5			V
VOL	Low-level output voltage, RE	SET		I <sub>OL</sub> = 16 mA				0.4	V
V <sub>ref</sub>	Reference voltage			I <sub>ref</sub> = 500 μA		2.48	2.53	2.58	V
\/	, Negative-going input threshold voltage		TL7702BY			2.505	2.53	2.555	V
VIT-	at SENSE input		TL7705BY	]		4.5	4.55	4.6	v
\/.	Uniteresia CENCE (V )	/ \	TL7702BY	V <sub>CC</sub> = 3.6 V to 18 V			10		mV
V <sub>hys</sub>	Hysteresis, SENSE (V <sub>IT+</sub> – V	/11–)	TL7705BY				30		IIIV
V <sub>res</sub> ‡	Power-up reset voltage			I <sub>OL</sub> at RESET = 2	mA			1	V
Ţ.,	Input ourrent	RESIN		$V_I = 0.4 \text{ V to } V_{CC}$				-10	
'1	Input current	SENSE	TL7702BY	$V_I = V_{ref}$ to 18 V			-0.1	-2	μΑ
ІОН	IOH High-level output current, RESET		V <sub>O</sub> = 18 V,	See Figure 1			50	μΑ	
loL	DL Low-level output current, RESET		$V_0 = 0 V$ ,	See Figure 1			-50	μΑ	
Icc	Supply current			V <sub>SENSE</sub> = 15 V,	RESIN ≥ 2 V		1.8	3	mA

<sup>†</sup> All electrical characteristics are measured with 0.1-μF capacitors connected at REF, CT, and V<sub>CC</sub> to GND. ‡ This is the lowest voltage at which RESET becomes active.

# switching characteristics, $V_{CC}$ = 5 V, CT open, $T_A$ = 25°C

	PARAMETER	FROM (INPUT)	I TEST CONDITIONS I ILI/U3DI				UNIT		
		(1141-01)	(0011-01)		MIN	TYP	MAX		
tPLH	Propagation delay time from low- to high-level output	RESIN	RESET	See Figures 1. 2. and 2.		270	500	ns	
<sup>t</sup> PHL	Propagation delay time from high- to low-level output	RESIN	RESET	See Figures 1, 2, and 3		270	500	ns	
	Effective pulse duration			Coo Figure 2		150			
t <sub>W</sub>	Effective pulse duration	SENSE		See Figure 2		100		ns	
t <sub>r</sub>	Rise time		DECET				75	ns	
t <sub>f</sub>	Fall time		RESET	See Figures 1 and 3		150	200	115	
t <sub>r</sub>	Rise time		RESET	See rigules railus		75	150	ns	
t <sub>f</sub>	Fall time		RESET				50	115	

## PARAMETER MEASUREMENT INFORMATION



NOTES: A. For I $_{OL}$  and I $_{OH}$ , R $_{L}$  = 10 k $\Omega$ . For all switching characteristics, R $_{L}$  = 511  $\Omega$ .

B. This figure includes jig and probe capacitance.

Figure 1. RESET and RESET Output Configurations



Figure 2. Input Pulse Definition

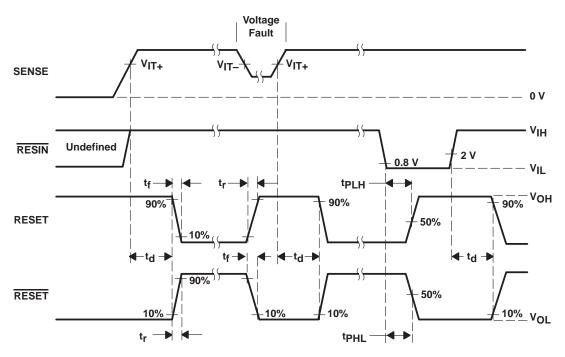
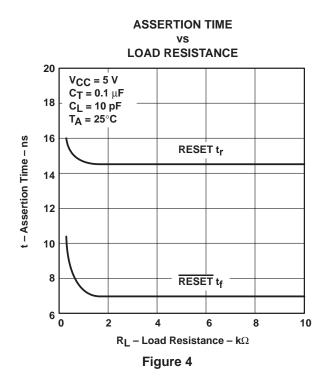
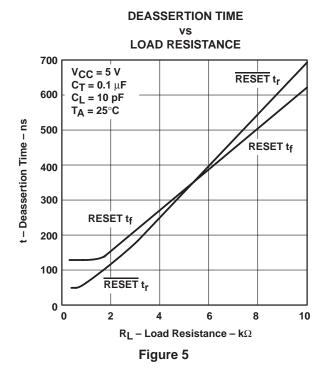


Figure 3. Voltage Waveforms

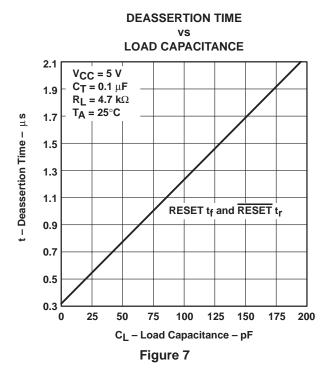


### TYPICAL CHARACTERISTICS†





### **ASSERTION TIME** VS **LOAD CAPACITANCE** 36 V<sub>CC</sub> = 5 V $C_T = 0.1 \,\mu F$ $R_L = 4.7 \text{ k}\Omega$ 30 T<sub>A</sub> = 25°C t - Assertion Time - ns 24 RESET tr 18 RESET tf 12 6 0 25 50 75 100 125 150 175 200 C<sub>L</sub> - Load Capacitance - pF Figure 6



<sup>†</sup> For proper operation, both RESET and RESET should be terminated with resistors of similar value. Failure to do so may cause unwanted plateauing in either output waveform during switching.



### **APPLICATION INFORMATION**

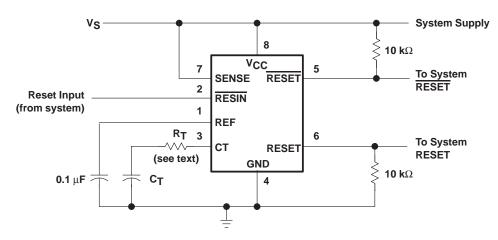


Figure 8. System Reset Controller With Undervoltage Sensing

When the TL770xB SENSE terminal is used to monitor V<sub>CC</sub>, a current-limiting resistor in series with C<sub>T</sub> is recommended. During normal operation, the timing capacitor is charged by the onboard current source to approximately V<sub>CC</sub> or an internal voltage clamp (≈7.1-V zener), whichever is less. When the circuit is then subjected to an undervoltage condition during which  $V_{CC}$  is rapidly slewed down, the voltage on CT exceeds that on  $V_{CC}$ . This forward biases a secondary path internally, which falsely activates the outputs. A fault is indicated when VCC drops below V<sub>(CT)</sub>, not when V<sub>SENSE</sub> falls below V<sub>T</sub>.

Texas Instruments performs a 100% electrical screen to verify that the outputs do not switch with 1 mA forced into the CT terminal. Adding the external resistor, R<sub>T</sub>, prevents false triggering. Its value is calculated as follows:

$$\frac{V_{(CT)}-V_{T_-}}{R_\tau}$$

Where:

 $V_{(CT)} = V_{CC} \text{ or 7.1 V, whichever is less}$   $V_{T-} = 4.55 \text{ V (nom)}$ 

= value of series resistor required

For  $V_{CC} = 5 \text{ V}$ :

$$\frac{5\,-\,4.55}{R_{\scriptscriptstyle T}} \;<\; 1\;\, mA$$

Therefore.

$$R_{T}$$
 > 450  $\Omega$ 

Using a 20% tolerance resistor,  $R_T$  should be greater than 560  $\Omega$ .

Adding this series resistor changes the duration of the reset pulse by no more than 10%. RT extends the discharge of C<sub>T</sub>, but also skews the V<sub>(CT)</sub> threshold. These effects tend to cancel one another. The precise percentage change can be derived theoretically, but the equation is complicated by this interaction and is dependent upon the duration of the supply-voltage fault condition.

Both outputs of the TL770xB should be terminated with similar value resistors, even when only one is being used. This prevents unwanted plateauing in either output waveform during switching, which may be interpreted as an undefined state or delay system reset.



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